WNSC2D051200



## Silicon Carbide Diode

Rev.01 - 21 June 2022

**Product data sheet** 

### **1. General description**

Silicon Carbide Schottky diode in a TO220-2L plastic package, designed for high frequency switched-mode power supplies.



### 2. Features and benefits

- Highly stable switching performance
- High forward surge capability I<sub>FSM</sub>
- Extremely fast reverse recovery time
- · Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T<sub>i(max)</sub> = 175 °C)

### 3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

## 4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute	maximum rating						
$V_{\text{RRM}}$	repetitive peak reverse voltage			1200			V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 150 °C; Fig. 1; Fig. 2; Fig. 3		5		А	
T <sub>j</sub>	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min Typ Max		Unit	
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 5 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I <sub>F</sub> = 5 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
Dynamic	characteristics				,		
Q <sub>r</sub>	recovered charge	I <sub>F</sub> = 5 A; dI <sub>F</sub> /dt = 500 A/μs; V <sub>R</sub> = 400 V; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>		-	11	-	nC

## 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	к_И_А
2	A	anode	]	K <u>–                                   </u>
mb	mb	mounting base; connected to cathode		

## 6. Ordering information

Table 3. Ordering information								
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WNSC2D051200	TO220-2L	WNSC2D0512006Q	Tube	50	SOD59A	30-Mar-2015		

## 7. Marking

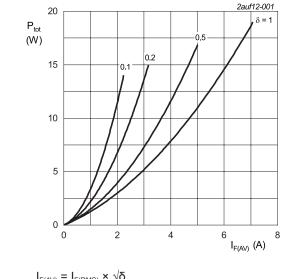
Table 4. Marking codes					
Type number	Marking codes				
WNSC2D051200	WNSC2D 051200				

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage			1200	V
$V_{\text{RWM}}$	crest working reverse voltage			1200	V
V <sub>R</sub>	reverse voltage	DC		1200	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5; square-wave pulse; T <sub>mb</sub> ≤ 150 °C; Fig. 1; Fig. 2; Fig. 3		5	A
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 150 °C; square-wave pulse		10	A
I <sub>FSM</sub>	non-repetitive peak	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		50	А
	forward current	$t_p = 10 \ \mu s; T_{j(init)} = 25 \ ^{\circ}C; square-wave pulse$		450	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms		13	A <sup>2</sup> s
T <sub>stg</sub>	storage temperature			-55 to 175	°C
Tj	junction temperature			175	°C



I<sub>F(AV)</sub> = I<sub>F(RMS)</sub> × √δ
V<sub>o</sub> = 1.027 V; R<sub>s</sub> = 0.2336 Ω
Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

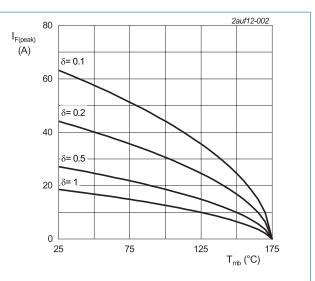
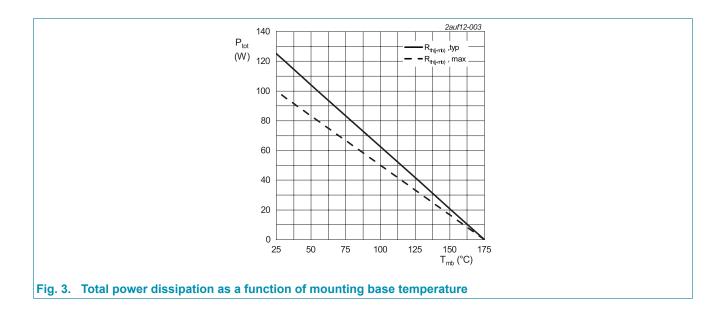


Fig. 2. Current derating as a function of mounting base temperature

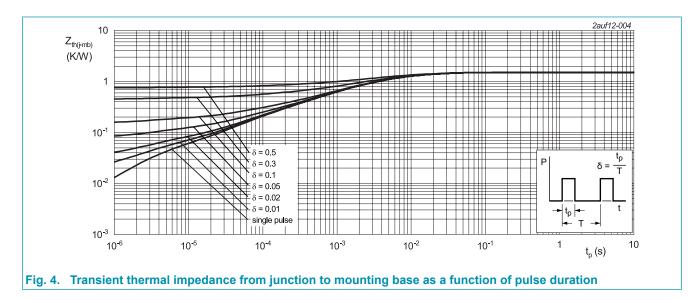
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### WNSC2D051200 Silicon Carbide Diode



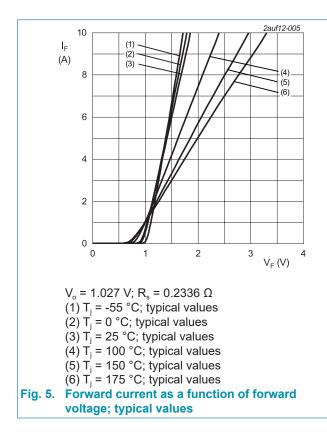
## 9. Thermal characteristics

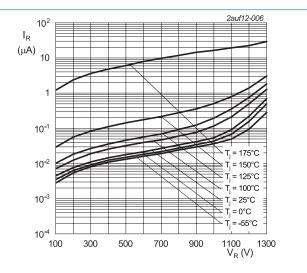
Fable 6. Thermal characteristics								
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit	
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 4</u>		-	1.2	1.5	K/W	
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W	



### **10. Characteristics**

Table 7. Cl	haracteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
V <sub>F</sub>	forward current	I <sub>F</sub> = 5 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I <sub>F</sub> = 5 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
		I <sub>F</sub> = 5 A; T <sub>j</sub> = 175 °C; <u>Fig. 5</u>		-	2.00	2.50	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1200 V; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>		-	0.5	25	μA
		V <sub>R</sub> = 1200 V; T <sub>j</sub> = 175 °C; <u>Fig. 6</u>		-	25	300	μA
Dynamic	characteristics		_	,		_	_
Q <sub>r</sub>	recovered charge	$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \frac{\text{Fig. 7}}{2}$		-	11	-	nC
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 1 V; T <sub>j</sub> = 25 °C		-	260	-	pF
		f = 1 MHz; V <sub>R</sub> = 400 V; T <sub>j</sub> = 25 °C		-	22	-	pF
		f = 1 MHz; V <sub>R</sub> = 800 V; T <sub>j</sub> = 25 °C		-	16	-	pF
E <sub>as</sub>	non-repetitive avalanche energy	$I_R$ = 2.9 A; L = 10 mH; $T_{j(init)}$ = 25 °C		42	-	-	mJ



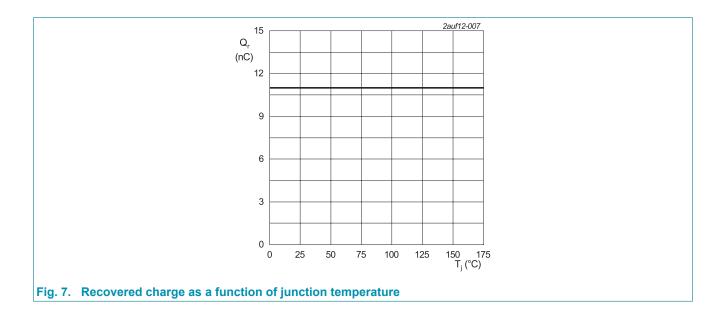




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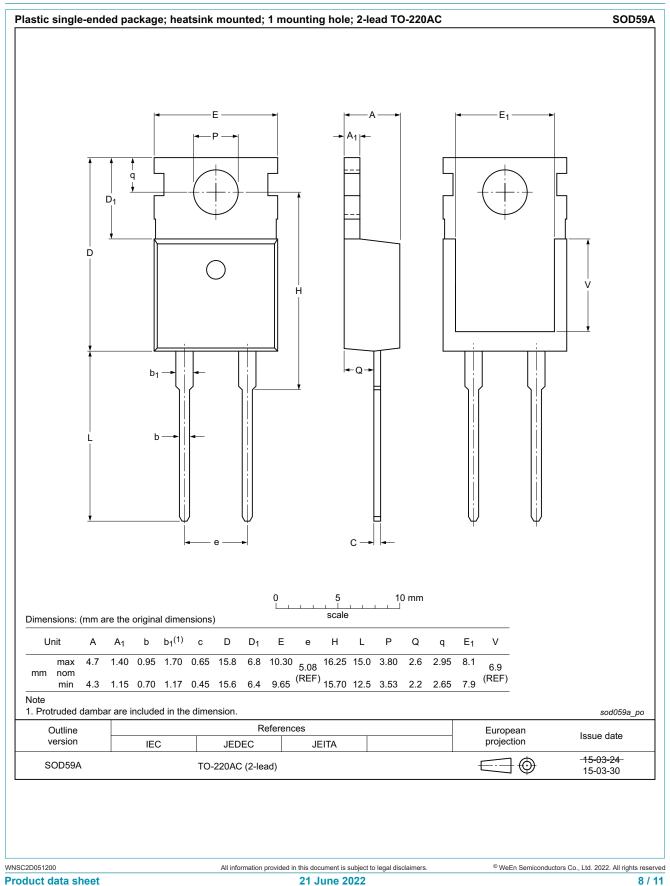
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#### WNSC2D051200 Silicon Carbide Diode

### **11. Package outline**



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#### Silicon Carbide Diode

## 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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